

Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Glass passivated chip junction
- High surge forward current capability
- Ideal for automated placement
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Component in accordance to RoHS 2015/863/EU

Mechanical data

- Case:JBF molded plastic body
- Terminals:Plated leads solderable per MIL-STD-750,method 2026
- Polarity:As marked
- Mounting Position:Any

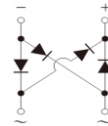
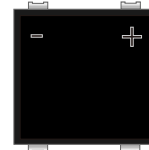
APPLICATIONS

- Used in high frequency AC/DC bridge full wave rectification for SMPS, lighting ballaster, adapter, battery charger, home appliances, office equipment, and telecommunication applications.

JBF



HALOGEN
FREE



Maximum Ratings And Electrical Characteristics

(Ratings at 25°C ambient temperature unless otherwise specified ,Single phase ,half wave ,resistive or inductive load. For capacitive load,derate by 20%.)

Parameters	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	600	V
Maximum average forward rectified current	$I_{F(AV)}$	4.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method,Total device)	I_{FSM}	220	A
Rating for fusing($t < 8.3ms$)	I^2t	201	A ² S
Operating junction temperature range	T_j	-55 to 150	°C
Storage temperature range	T_{stg}	-55 to 150	°C

RATINGS AND CHARACTERISTICS JBF406L

Electrical Characteristics (Per diode, $T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Test Conditions		Symbol	Min.	Typ.	Max.	Unit
Breakdown voltage Blocking voltage	$I_r=10\mu\text{A}$		V_{BR} V_R	620	-	-	V
Instaneous forward voltage	$T_j=25^\circ\text{C}$	$I_f=1.0\text{A}$	$V_F^{1)}$	-	0.81	-	V
		$I_f=4.0\text{A}$		-	0.87	0.95	
	$T_j=125^\circ\text{C}$	$I_f=1.0\text{A}$		-	0.67	-	
		$I_f=4.0\text{A}$		-	0.75	0.83	
Reverse current	$T_j=25^\circ\text{C}$	$V_R=600\text{V}$	$I_R^{2)}$	-	-	5	μA
	$T_j=125^\circ\text{C}$			-	-	250	
Junction capacitance	4V,1MHz		C _J	-	83	-	pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle

2.Pulse test: pulse width $\leq 40\text{ms}$

Thermal Characteristics

Parameter	Symbol	JBF	Unit
Typical thermal resistance ³⁾	R _{θJC}	5.0	$^\circ\text{C}/\text{W}$

3.Thermal resistance from per diode junction to case

RATINGS AND CHARACTERISTICS JBF406L

Fig.1-Forward Current Derating Curve

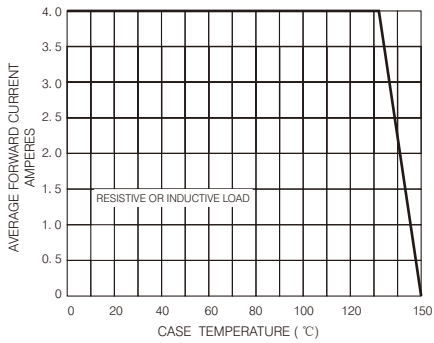


Fig.2-Maximum Non-repetitive Peak Forward Surge Current

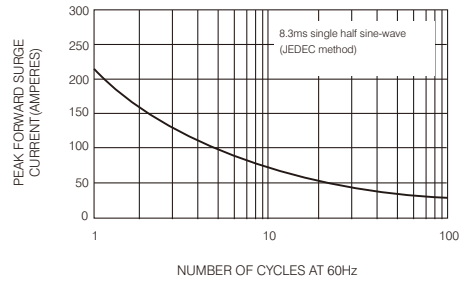


Fig.3-Typical Instantaneous Forward Characteristics

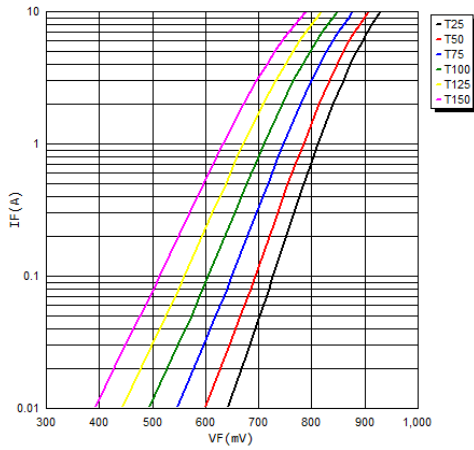
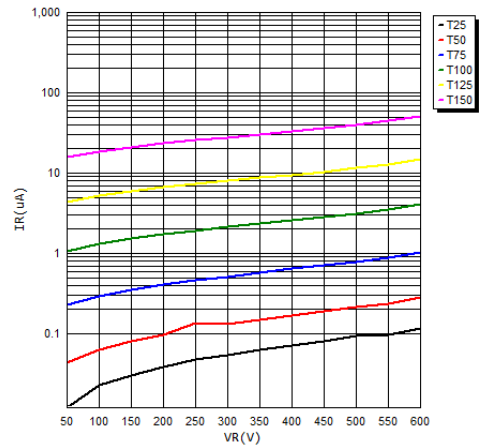
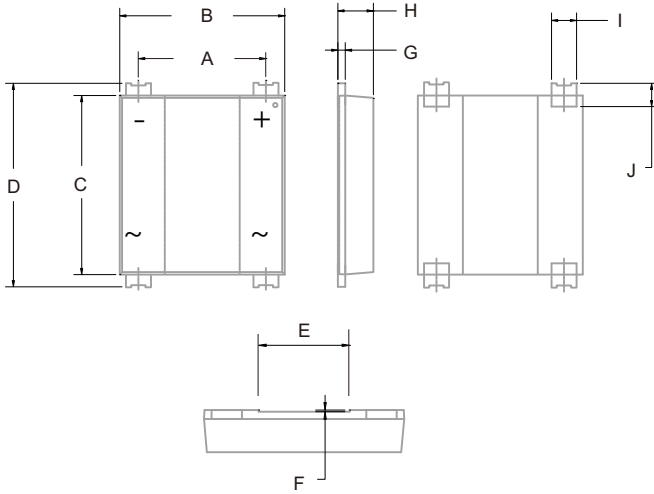


Fig.4-Typical Reverse Characteristics



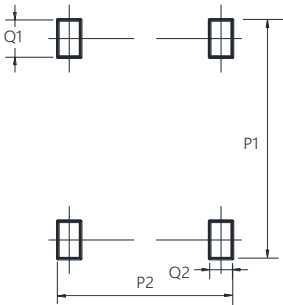
PACKAGE OUTLINE DIMENSIONS

JBF



UNIT:mm		
DIM	MIN	MAX
A	4.80	5.30
B	6.20	7.00
C	7.10	8.20
D	7.90	8.90
E	2.90	3.10
F	0.04	0.08
G	0.15	0.40
H	1.30	1.50
I	0.80	1.20
J	0.70	1.60

Suggested Pad layout



Dimensions in millimeters

Dim	Min
P1	9.15
P2	7.10
Q1	1.80
Q2	2.00

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